Vishay Polytech

vPolyTan[™] Polymer Surface-Mount Chip Capacitors, Molded Case, High Performance Type



www.vishay.com

LINKS TO ADDITIONAL RESOURCES



PERFORMANCE / ELECTRICAL CHARACTERISTICS

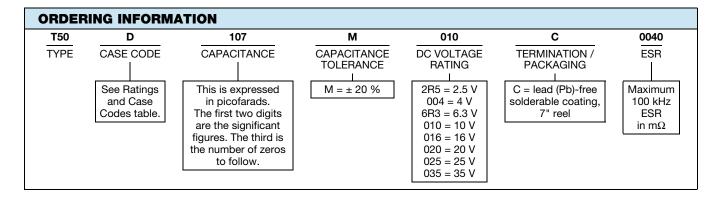
Operating Temperature: -55 °C to +125 °C (above 105 °C, voltage derating is required) **Capacitance Range:** 10 μ F to 330 μ F **Capacitance Tolerance:** \pm 20 % **Voltage Rating:** 2.5 V_{DC} to 35 V_{DC}

FEATURES

- Operating temperature range of -55 °C to +125 °C
- High temperature and high humidity operation
- Qualification testing based on AEC-Q200 with 85 $^\circ\text{C}$ / 85 % RH performance testing up to 500 hours
- Ultra low ESR
- Molded case 7343-31 EIA size
- Terminations: Ni / Pd / Au
- Moisture sensitivity level 3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Decoupling, smoothing, filtering
- · Switch mode and point of load power supply
- Automotive infotainment and cockpit electronics
- Storage and networking infrastructure equipment
- Industrial applications requiring high temperature operation



DIMENSIONS in inches [millimeters]							
CASE CODE	EIA SIZE	L	W	Н	I	а	
D	7343-31	0.287 ± 0.008 [7.3 ± 0.2]	0.169 ± 0.012 [4.3 ± 0.3]	0.110 ± 0.012 [2.8 ± 0.3]	0.051 ± 0.012 [1.3 ± 0.3]	0.094 ± 0.008 [2.4 ± 0.2]	

Revision: 08-Apr-2025

Pb-free RoHS

COMPLIANT HALOGEN FREE GREEN (5-2008)

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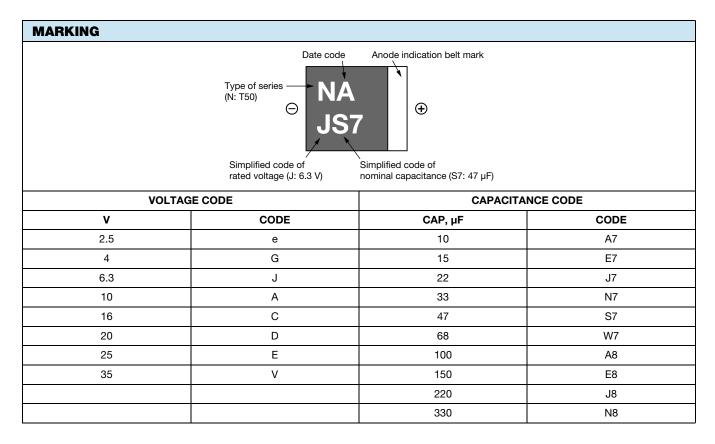
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T50



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•							
RATINGS AND CASE CODES							
μF	2.5 V	4.0 V	6.3 V	10 V	16 V	25 V	35 V
10							D
33					D	D	
47					D		
100				D	D		
150			D				
220	D	D	D	D			
330	D	D	D				



DATE	DATE CODE											
YEAR		MONTH										
TEAN	1	2	3	4	5	6	7	8	9	10	11	12
2021	А	В	С	D	E	F	G	Н	J	К	L	М
2022	Ν	Р	Q	R	S	Т	U	V	W	Х	Y	Z
2023	а	b	с	d	е	f	g	h	j	k	I	m
2024	n	р	q	r	S	t	u	v	w	х	У	z
2025	А	В	С	D	E	F	G	Н	J	К	L	М
2026	Ν	Р	Q	R	S	Т	U	V	W	Х	Y	Z

Note

• Marking code repeats every four years in alphabetical order (letter of I, i, O, and o are excluded)

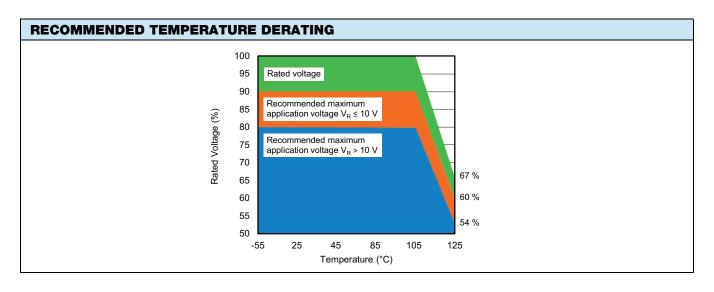
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STANDARD	RATING	S					
CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT 25 °C (μΑ)	MAX. DF AT 25 °C 120 Hz (%)	MAX. ESR AT 25 °C 100 kHz (mΩ)	MAX. RIPPLE AT 45 °C 100 kHz I _{RMS} (A)	HIGH TEMPERATURE LOAD, TIME (h)
		2.5 V _{DC}	AT +105 °C; 1.	7 V _{DC} AT 125	°C		
220	D	T50D227M2R5C0025	55.0	10	25	3.00	2000
330	D	T50D337M2R5C0025	82.5	10	25	3.00	2000
4 V _{DC} AT +105 °C; 2.7 V _{DC} AT 125 °C							
220	D	T50D227M004C0025	88.0	10	25	3.00	2000
330	D	T50D337M004C0025	132.0	10	25	3.00	2000
		6.3 V _{DC}	AT +105 °C; 4.	2 V _{DC} AT 125	°C		
150	D	T50D157M6R3C0025	94.5	10	25	3.00	2000
220	D	T50D227M6R3C0025	138.6	10	25	3.00	2000
330	D	T50D337M6R3C0025	207.9	10	25	3.00	2000
		10 V _{DC}	AT +105 °C; 6.7	7 V _{DC} AT 125	°C		
100	D	T50D107M010C0040	100.0	10	40	2.37	2000
220	D	T50D227M010C0040	220.0	10	40	2.37	2000
		16 V _{DC} /	AT +105 °C; 10.	7 V _{DC} AT 125	°C		
33	D	T50D336M016C0070	52.8	10	70	1.79	1000
47	D	T50D476M016C0070	75.2	10	70	1.79	1000
100	D	T50D107M016C0050	160.0	10	50	2.12	1000
			AT +105 °C; 16.	8 V _{DC} AT 125			
33	D	T50D336M025C0060	82.5	10	60	1.93	1000
33	D	T50D336M025C0100	82.5	10	100	1.50	1000
		35 V _{DC} /	AT +105 °C; 23.	5 V _{DC} AT 125	°C		
10	D	T50D106M035C0120	35.0	10	120	1.36	1000

RECOMMENDED VOLTAGE DERATING GUIDELINES						
CAPACITOR VOLTAGE RATING AT -55 °C TO +105 °C	CAPACITOR CATEGORY VOLTAGE ABOVE +105 °C TO +125 °C	RECOMMENDED VOLTAGE DERATING AT -55 °C TO +105 °C	RECOMMENDED VOLTAGE DERATING ABOVE +105 °C TO +125 °C			
2.5	1.7	2.3	1.5			
4	2.7	3.6	2.4			
6.3	4.2	5.7	3.8			
10	6.7	9	6.0			
16	10.7	12.8	8.6			
25	16.8	20	13.5			
35	23.5	28	18.9			



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T50

 POWER DISSIPATION

 CASE CODE
 MAXIMUM PERMISSIBLE POWER DISSIPATION (W) AT ≤ +45 °C IN FREE AIR

 D
 0.225

 STANDARD PACKAGING QUANTITY

 CASE CODE
 UNITS PER 7" REEL

 D
 500

PERFORMANC	E CHARACTERISTICS			
ITEM	CONDITION	POST TEST PERFOR	MANCE	
	2000 h, rated voltage applied at 105 °C	Capacitance change	Within \pm 20 % of initial value	
	2000 h, 2/3 rated voltage applied at 125 °C	Dissipation factor	Within initial limits	
Endurance	(for < 16 V parts) 1000 h, 2/3 rated voltage applied at 125 °C	Leakage current	Shall not exceed 300 % of initial limit	
	(for ≥ 16 V parts)	ESR	Shall not exceed 300 % of initial limit	
		Capacitance change	Within ± 20 % of initial value	
	2000 h no voltage applied at 105 °C	Dissipation factor	Within initial limits	
Shelf life test	1000 h no voltage applied at 125 °C	Leakage current	Shall not exceed 300 % of initial limit	
		ESR	Shall not exceed 300 % of initial limit	
		Capacitance change	-5 % to +50 % of initial value (≤ 4 V) -5 % to +40 % of initial value (≥ 6.3 V)	
Humidity test	500 h, rated voltage applied at 85 °C / 85 % RH	Dissipation factor	Within initial limit	
-		Leakage current	Shall not exceed 300 % of initial limit	
		ESR	Shall not exceed 300 % of initial limit	
		Capacitance change	Within ± 30 % of initial value	
	-55 °C	Dissipation factor	Within initial limit	
		Leakage current	n/a	
	25 °C	Capacitance change	Within ± 20 % of initial value	
		Dissipation factor	Within initial limit	
Stability at low and		Leakage current	Within initial limit	
high temperatures		Capacitance change	Within ± 30 % of initial value	
	85 °C	Dissipation factor	Shall not exceed 120 % of initial limit	
		Leakage current	Shall not exceed 1000 % of initial value	
		Capacitance change	Within 0 % to +50 % of initial value	
	105 °C / 125 °C	Dissipation factor	Shall not exceed 150 % of initial limit	
		Leakage current	Shall not exceed 1000 % of initial limit	
	105 °C, 1.3 rated voltage,	Capacitance change	Within ± 20 % of initial value	
Surge voltage	125 °C, 1.3 x 2/3 rated voltage,	Dissipation factor	Within initial limit	
Ourge voltage	1000 successive test cycles with 33 Ω at the rate	Leakage current	Shall not exceed 300 % of initial limit	
	of 30 s ON, 30 s OFF	ESR	Shall not exceed 300 % of initial limit	
		Capacitance change	Within ± 20 % of initial value	
Shock	MIL-STD-202, figure 1 of method 213,	Dissipation factor	Within initial limit	
(specified pulse)	condition F	Leakage current	Within initial limit	
(1)		There shall be no mechanical or visual damage to capacitors post-conditioning.		
		Capacitance change	Within \pm 20 % of initial value	
	MIL-STD-202, method 204, 5 g's for 20 min.,	Dissipation factor	Within initial limit	
Vibration	12 cycles each of 3 orientations.	Leakage current	Within initial limit	
	Test from 10 Hz to 2000 Hz.	There shall be no mechanical or visual damage to capacitors post-conditioning.		

PRODUCT INFORMATION	
Polymer Guide	www.vishay.com/doc?40076
Moisture Sensitivity	www.vishay.com/doc?40135
Infographic	www.vishay.com/doc?48084
Sample Board	www.vishay.com/doc?48073
FAQ	
Frequently Asked Questions	www.vishay.com/doc?42106

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Guide for Tantalum Solid Electrolyte Chip Capacitors With Polymer Cathode

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum/tantalum oxide/manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve"metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance/volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance/volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS				
DIELECTRIC	e DIELECTRIC CONSTANT			
Air or vacuum	1.0			
Paper	2.0 to 6.0			
Plastic	2.1 to 6.0			
Mineral oil	2.2 to 2.3			
Silicone oil	2.7 to 2.8			
Quartz	3.8 to 4.4			
Glass	4.8 to 8.0			
Porcelain	5.1 to 5.9			
Mica	5.4 to 8.7			
Aluminum oxide	8.4			
Tantalum pentoxide	26			
Ceramic	12 to 400K			

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

Revision: 10-Dec-2024

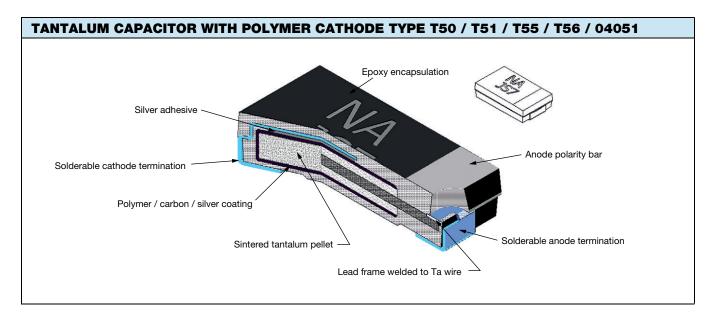


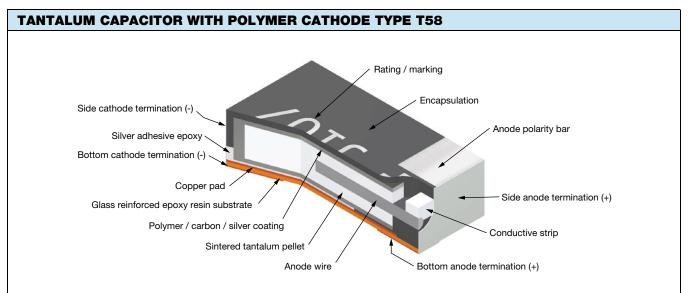
SOLID ELECTROLYTE POLYMER TANTALUM CAPACITORS

Solid electrolyte polymer capacitors utilize sintered tantalum pellets as anodes. Tantalum pentoxide dielectric layer is formed on the entire surface of anode, which is further impregnated with highly conductive polymer as cathode system.

The conductive polymer layer is then coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the capacitor element and the outer termination (lead frame or other).

Molded chip polymer tantalum capacitor encases the element in plastic resins, such as epoxy materials. The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for variety of applications in electronic devices. Usage of conductive polymer cathode system provides very low equivalent series resistance (ESR), which makes the capacitors particularly suitable for high frequency applications.

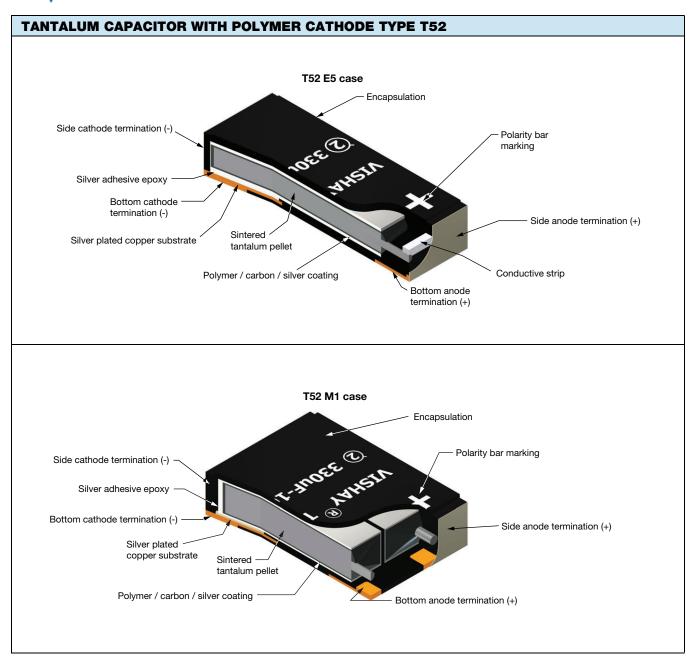






Polymer Guide

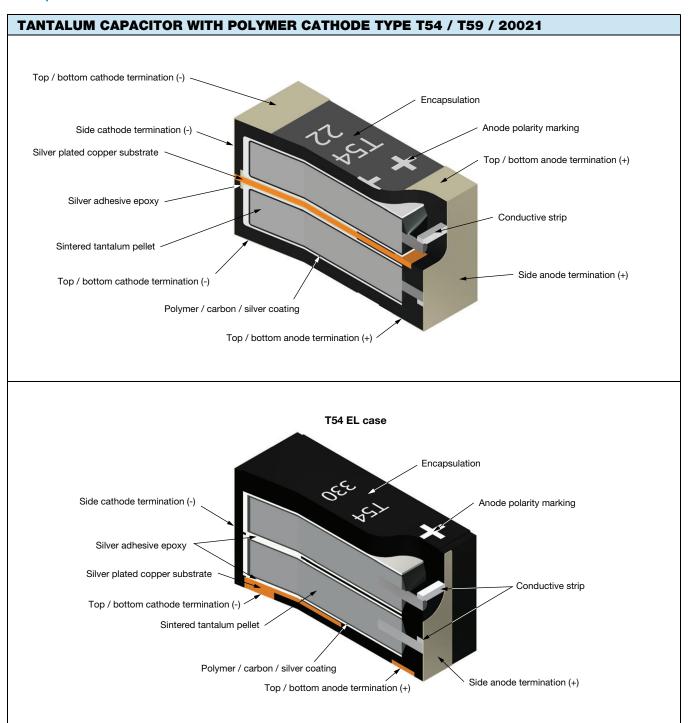
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Polymer Guide

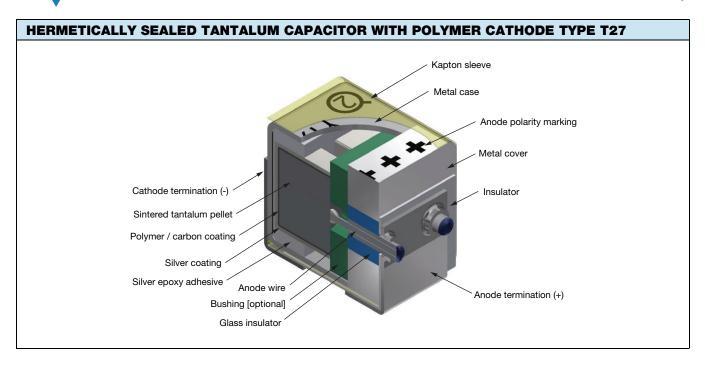
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POLYMER CAPACITORS - METAL CASE, HERMETICALLY SEALED				
SERIES	T27			
PRODUCT IMAGE				
ТҮРЕ	VPolyTan [™] hermetically sealed polymer surface-mount chip capacitors, low ESR			
FEATURES	Hermetically sealed in metal case, low ESR / low DCL, hi-rel. processing			
TEMPERATURE RANGE	-55 °C to +125 °C			
CAPACITANCE RANGE	15 μF to 470 μF			
VOLTAGE RANGE	16 V to 75 V			
CAPACITANCE TOLERANCE	± 20 %			
LEAKAGE CURRENT	0.05 CV			
DISSIPATION FACTOR	12 %			
ESR	$25 \text{ m}\Omega$ to 100 m Ω			
CASE SIZES	D			
TERMINATION FINISH	100 % tin; tin / lead			

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POLYMER CAPACITORS - MOLDED CASE					
SERIES	T50, T51, T55, T56	04051			
PRODUCT IMAGE	Find Find Find	Fiel Fiel Fiel			
ТҮРЕ	VPolyTan [™] , molded case, high performance polymer	VPolyTan [™] , molded case, high performance polymer			
FEATURES	High performance	High performance			
TEMPERATURE RANGE	-55 °C to +105 °C / +125 °C	-55 °C to +125 °C (above +105 °C, voltage derating is required)			
CAPACITANCE RANGE	3.3 μF to 1000 μF	4.7 μF to 680 μF			
VOLTAGE RANGE	2.5 V to 63 V	2.5 V to 63 V			
CAPACITANCE TOLERANCE	± 20 %	± 10 %, ± 20 %			
LEAKAGE CURRENT	0.1 CV	0.1 CV			
DISSIPATION FACTOR	8 % to 10 %	8 % to 10 %			
ESR	6 m Ω to 500 m Ω	$25 \text{ m}\Omega$ to $125 \text{ m}\Omega$			
CASE SIZES	J, P, A, T, B, Z, V, D, C	B, D			
TERMINATION FINISH	Cases J, P, C: 100 % tin Case A, T, B, Z, V, D: Ni / Pd / Au	All cases: tin / lead (SnPb)			

POLYMER C	APACITORS - LE	ADFRAMELESS M	IOLDED CASE		
SERIES	T52	T58	T59	T54	20021
PRODUCT IMAGE		Succession and a succes		P	A A A A A A A A A A A A A A A A A A A
ТҮРЕ	vPolyTan TM polymer surface mount chip capacitors, low profile, leadframeless molded type	vPolyTan [™] polymer surface mount chip capacitors, compact, leadframeless molded type	vPolyTan [™] polymer surface mount chip capacitors, low ESR, leadframeless molded type	vPolyTan [™] polymer surface mount chip capacitors, low ESR, leadframeless molded type, hi-rel commercial off-the-shelf (COTS)	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type, DLA approved
FEATURES	Low profile	Small case size	Multianode	Hi-rel COTS, multianode	Multianode
TEMPERATURE RANGE	-55 °C to +105 °C	-55 °C to +105 °C	-55 °C to +125 °C	-55 °C to +125 °C	-55 °C to +125 °C
CAPACITANCE RANGE	47 μF to 470 μF	1 μF to 100 μF	15 μF to 470 μF	15 μF to 470 μF (discrete capacitors) 30 μF to 2800 μF (stacked capacitors)	15 μF to 470 μF (discrete capacitors) 30 μF to 2800 μF (stacked capacitors)
VOLTAGE RANGE	10 V to 35 V	6.3 V to 35 V	16 V to 75 V	16 V to 75 V	16 V to 75 V
CAPACITANCE TOLERANCE	± 20 %	± 20 %	± 10 %, ± 20 %	± 20 %	± 20 %
LEAKAGE CURRENT			0.1 CV		
DISSIPATION FACTOR	10 %	8 % to 14 %	10 % to 12 %	10 % to 12 %	10 % to 12 %
ESR	40 m Ω to 200 m Ω	90 m Ω to 500 m Ω	20 m Ω to 150 m Ω	5 m Ω to 150 m Ω	5 m Ω to 150 m Ω
CASE SIZES	E5, M1, M9, B2	MM, W0, W9, A0, BB	EE, EL	EE, EL, E2, E3, E4, E6, 3E, 6E	EE, E2, E3, E4, E6, 3E, 6E
TERMINATION	100	% tin	100 % tin	; tin / lead	Tin / lead

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Polymer Guide



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MOLDED CAPACITORS, T50 / T51 / T55 / T56 / 04051 TYPES

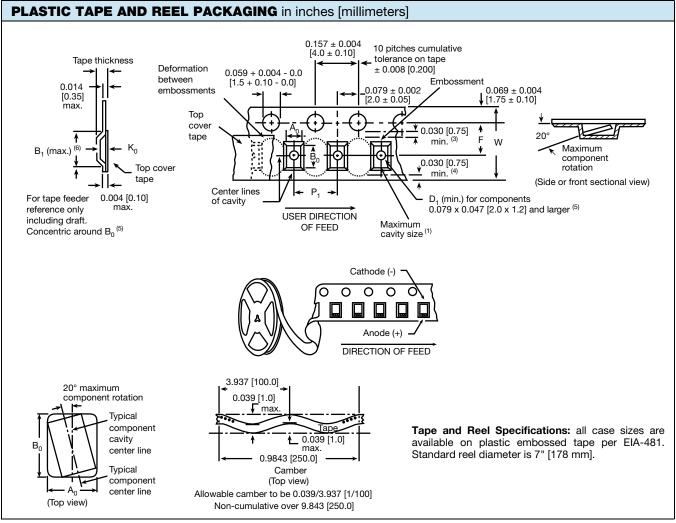
PLASTIC TAPE SIZE DIMENSIONS in millimeters							
Perforation $0 1.5^{+0.1}$ $0 1.5^{+0.1}$							
	Perforation Symbol: R Marking side (upper) Marking side (upper) Marking side (upper) Mounting terminal side (lower))
CASE CODE	A ± 0.2	B ± 0.2	W ± 0.3	F ± 0.1	E ± 0.1	P ₁ ± 0.1	t _{max.}
J	1.0	1.8	8.0	3.5	1.75	4.0	1.3
Р	1.4	2.2	8.0	3.5	1.75	4.0	1.6
A	1.9	3.5	8.0	3.5	1.75	4.0	2.5
Т	3.1	3.8	8.0	3.5	1.75	4.0	1.7
В	3.1	3.8	8.0	3.5	1.75	4.0	2.5
С	3.7	6.3	12.0	5.5	1.75	8.0	3.1
Z	4.8	7.7	12.0	5.5	1.75	8.0	2.6
V	4.8	7.7	12.0	5.5	1.75	8.0	2.6
D	4.8	7.7	12.0	5.5	1.75	8.0	3.4

Note

• A reel diameter of 330 mm is also applicable



LEADFRAMELESS MOLDED CAPACITORS, ALL TYPES



Notes

- · Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- ⁽³⁾ This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- ⁽⁵⁾ The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- ⁽⁶⁾ B₁ dimension is a reference dimension tape feeder clearance only



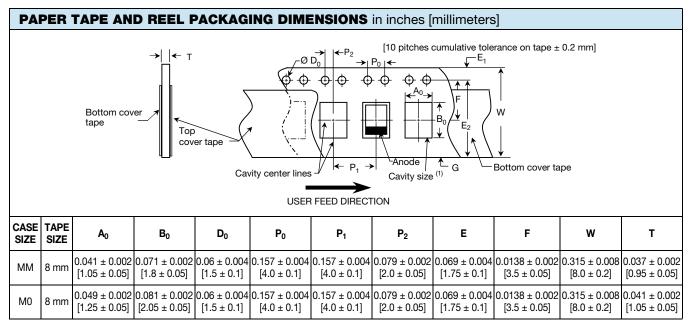
CARRIER TAPE DIMENSIONS in inches [millimeters]								
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	P ₂	w
E5	12 mm	0.329 [8.35]	0.059 [1.5]	0.217 ± 0.002 [5.50 ± 0.05]	0.071 [1.8]	$\begin{array}{c} 0.315 \pm 0.004 \\ [8.0 \pm 0.10] \end{array}$	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.476 ± 0.008 [12.1 ± 0.20]
MM ⁽²⁾	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
M1, M9	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.094 [2.39]	0.315 ± 0.04 [8.0 ± 1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
W9	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
WO	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
A0	8 mm	-	0.02 [0.5]	0.138 [3.5]	0.049 [1.25]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
BB	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.087 [2.22]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
EE, EL	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.175 [4.44]	0.315 ± 0.04 [8.0 ±1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
B2	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.057 [1.45]	0.157 [4.0]	$\begin{array}{c} 0.079 \pm 0.002 \\ [2.00 \pm 0.05] \end{array}$	0.315 [8.0]
D ⁽³⁾	16 mm	0.321 [8.16]	0.059 [1.5]	0.295 ± 0.004 [7.50 ± 0.1]	0.308 [7.83]	$\begin{array}{c} 0.472 \pm 0.004 \\ [12.00 \pm 0.1] \end{array}$	$\begin{array}{c} 0.079 \pm 0.004 \\ [2.00 \pm 0.1] \end{array}$	0.630 ± 0.012 [16.00 ± 0.3]

Notes

⁽¹⁾ For reference only

(2) Standard packaging of MM case is with paper tape. Plastic tape is available per request

⁽³⁾ Tape thickness 0.018 [0.45] max.



Note

(1) A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

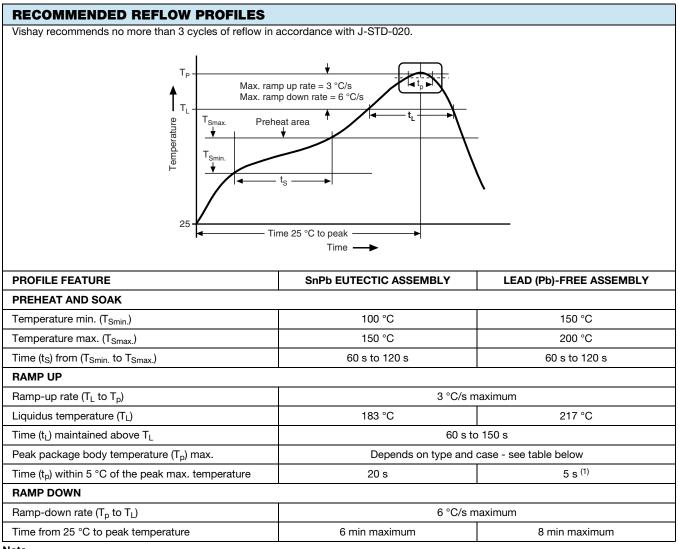
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PACKING AND STORAGE

Polymer capacitors meet moisture sensitivity level rating (MSL) of 3 or 4 as specified in IPC/JEDEC[®] J-STD-020 and are dry packaged in moisture barrier bags (MBB) per J-STD-033. MSL for each particular family is defined in the datasheet - either in "Features" section or "Standard Ratings" table. Level 3 specifies a floor life (out of bag) of 168 hours and level 4 specifies a floor life of 72 hours at 30 °C maximum and 60 % relative humidity (RH). Unused capacitors should be re-sealed in the MBB with fresh desiccant. A moisture strip (humidity indicator card) is included in the bag to assure dryness. To remove excess moisture, capacitors can be dried at 40 °C (standard "dry box" conditions).

For detailed recommendations please refer to J-STD-033.



Note

⁽¹⁾ For T27, lead (Pb)-free capacitors $t_p = 30$ s



PEAK PAC	PEAK PACKAGE BODY TEMPERATURE (T _D) MAXIMUM					
TYPE	CASE CODE	PEAK PACKAGE BODY TEMPERATURE (T _P) MAX.				
TIPE	CASE CODE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY			
T27	D	220 °C	245 °C			
T55	J, P, A, T, B, C, Z, V, D		260 °C			
T52	E5, M1, M9, B2	260 °C				
T58	MM, W9, W0, A0, BB		260 °C			
T50	D	n/a	260 °C			
T51	D, V		260 °C			
T56	B, V		260 °C			
T56	D		250 °C			
T59	EE, EL	220 °C	250 °C			
T54	EL, 3E, 6E, EE, E2, E3, E4, E6	220 °C	250 °C			
20021	3E, 6E, EE, E2, E3, E4, E6	220 °C	n/a			
04051	D	220 °C	n/a			
04051	В	235 °C	n/a			
M327001	D	220 °C	n/a			
M327001	B, C	235 °C	n/a			

Notes

 T54, T59, and T56 (D case) capacitors with 100 % tin termination are process sensitive. PSL classification to JEDEC J-STD-075: R6G

MOLDED CAPACITORS, T50 / T51 / T55 / T56 / 04051 TYPES

PAD DIMENSIONS in millimeters						
		Pattern ——	Capacitor Y G Z	w		
CASE /	CAPACITOR SIZE		PAD DIMENSIONS			
DIMENSIONS	L	w	G (max.)	Z (min.)	X (min.)	Y (Ref.)
J	1.6	0.8	0.7	2.5	1.0	0.9
Р	2.0	1.25	0.5	2.6	1.2	1.05
А	3.2	1.6	1.1	3.8	1.5	1.35
		2.8	1.4	4.1	2.7	1.35
T/B	3.5	2.0				
T/B C	3.5 5.8	3.2	2.9	6.9	2.7	2.0

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T50, T51, T52, T55, T56 (B, V cases), and T58 capacitors are process sensitive. PSL classification to JEDEC J-STD-075: R4G



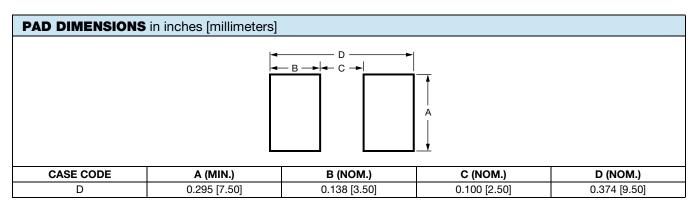
LEADFRAMELESS MOLDED CAPACITORS T52 / T58

AD DIMENSI	AD DIMENSIONS in inches [millimeters]							
			Pads	citor body				
FAMILY	CASE CODE	A (NOM.)	B (MIN.)	C (NOM.)	D (MIN.)			
	E5	0.094 [2.40]	0.077 [1.95]	0.180 [4.57]	0.333 [8.46]			
T52	M1, M9	0.178 [4.52]	0.098 [2.48]	0.138 [3.50]	0.333 [8.46]			
	B2	0.081 [2.06]	0.057 [1.44]	0.070 [1.77]	0.183 [4.64]			
750	MM	0.024 [0.61]	0.027 [0.70]	0.025 [0.64]	0.080 [2.03]			
	W0, W9	0.035 [0.89]	0.029 [0.74]	0.041 [1.05]	0.099 [2.52]			
T58	A0	0.047 [1.19]	0.042 [1.06]	0.065 [1.65]	0.148 [3.76]			
	BB	0.094 [2.39]	0.044 [1.11]	0.072 [1.82]	0.159 [4.03]			

LEADFRAMELESS MOLDED CAPACITORS T59 / T54 / 20021

PAD DIMENSIONS in inches [millimeters]							
$ \begin{array}{c} \bullet & \bullet \\ \bullet & \bullet $							
FAMILY	CASE CODE	A (NOM.)	B (MIN.)	C (NOM.)	D (MIN.)		
	EE	0.209 [5.30]	0.098 [2.50]	0.169 [4.30]	0.366 [9.30]		
T59 / T54	EL	0.098 [2.50]	0.098 [2.50]	0.169 [4.30]	0.366 [9.30]		
	E2 / E3	0.128 [3.24]	0.120 [3.04]	0.154 [3.92]	0.394 [10.0]		
TEA	E4 / E6	0.301 [7.64]	0.120 [3.04]	0.154 [3.92]	0.394 [10.0]		
T54	3E	0.482 [12.24]	0.120 [3.04]	0.154 [3.92]	0.394 [10.0]		
	6E	0.482 [12.24]	0.120 [3.04]	0.154 [3.92]	0.394 [10.0]		
20021	EE	0.209 [5.30]	0.098 [2.50]	0.169 [4.30]	0.366 [9.30]		

HERMETICALLY SEALED CAPACITOR T27 TYPE



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GUIDE TO APPLICATION

1. **AC Ripple Current:** the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

- P = power dissipation in W at +45 °C as given in the tables in the product datasheets.
- R_{ESR} = the capacitor equivalent series resistance at the specified frequency.
- 2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

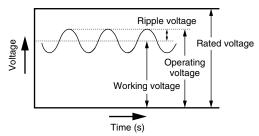
$$V_{RMS} = Z_{\sqrt{\frac{P}{R_{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

- P = power dissipation in W at +45 °C as given in the tables in the product datasheets.
- R_{ESR} = The capacitor equivalent series resistance at the specified frequency.
- Z = The capacitor impedance at the specified frequency.
- 2.1 The tantalum capacitors must be used in such a condition that the sum of the working voltage and ripple voltage peak values does not exceed the rated voltage as shown in figure below.



3. **Temperature Derating:** power dissipation is affected by the heat sinking capability of the mounting surface. If these capacitors are to be operated at temperatures above +45 °C, the permissible ripple current (or voltage) shall be calculated using the derating coefficient as shown in the table below:

MAXIMUM RIPPLE CURRENT TEMPERATURE DERATING FACTOR				
≤ 45 °C	1.0			
55 °C	0.8			
85 °C	0.6			
105 °C	0.4			
125 °C	0.25			

4. **Reverse Voltage:** the capacitors are not intended for use with reverse voltage applied. However, they are capable of withstanding momentary reverse voltage peaks, which must not exceed the following values: At 25 $^{\circ}\text{C}\text{:}$ 10 % of the rated voltage or 1 V, whichever is smaller.

At 85 $^{\circ}\text{C}\text{:}$ 5 % of the rated voltage or 0.5 V, whichever is smaller.

At 105 $^\circ\text{C:}$ 3 % of the rated voltage or 0.3 V, whichever is smaller.

5. Mounting Precautions:

- 5.1 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering, and hot plate methods. The soldering profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.
- 5.2 Limit Pressure on Capacitor Installation with Mounter: pressure must not exceed 4.9 N with a tool end diameter of 1.5 mm when applied to the capacitors using an absorber, centering tweezers, or similar (maximum permitted pressurization time: 5 s). An excessively low absorber setting position would result in not only the application of undue force to the capacitors but capacitor and other component scattering, circuit board wiring breakage, and / or cracking as well, particularly when the capacitors are mounted together with other chips having a height of 1 mm or less.

5.3 Flux Selection

- 5.3.1 Select a flux that contains a minimum of chlorine and amine.
- 5.3.2 After flux use, the chlorine and amine in the flux remain must be removed.
- 5.4 **Cleaning After Mounting:** the following solvents are usable when cleaning the capacitors after mounting. Never use a highly active solvent.
 - Halogen organic solvent (HCFC225, etc.)
 - Alcoholic solvent (IPA, ethanol, etc.)
 - Petroleum solvent, alkali saponifying agent, water, etc.

Circuit board cleaning must be conducted at a temperature of not higher than 50 °C and for an immersion time of not longer than 30 minutes. When an ultrasonic cleaning method is used, cleaning must be conducted at a frequency of 48 kHz or lower, at an vibrator output of 0.02 W/cm³, at a temperature of not higher than 40 °C, and for a time of 5 minutes or shorter.

Notes

- Care must be exercised in cleaning process so that the mounted capacitor will not come into contact with any cleaned object or the like or will not get rubbed by a stiff brush or similar. If such precautions are not taken particularly when the ultrasonic cleaning method is employed, terminal breakage may occur
- When performing ultrasonic cleaning under conditions other than stated above, conduct adequate advance checkout



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